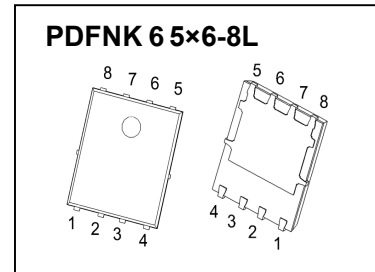




**PDFNK 6 5×6-8L Plastic-Encapsulate MOSFETS**

**CJAC100P03 P-Channel Power MOSFET**

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
-30V	2.3mΩ@-10V	-100A
	3.4mΩ@-4.5V	



**DESCRIPTION**

The CJAC100P03 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications

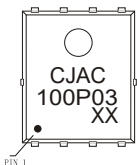
**FEATURES**

- Battery switch
- Load switch
- High density cell design for ultra low  $R_{DS(ON)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

**APPLICATIONS**

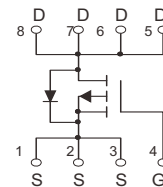
- SMPS and general purpose applications
- Hard switched and high frequency circuits
- Uninterruptible Power Supply

**MARKING**



CJAC100P03 = Part No.  
 Solid dot = Pin1 indicator  
 XX = Code

**EQUIVALENT CIRCUIT**



**MAXIMUM RATINGS (  $T_a=25^{\circ}C$  unless otherwise noted )**

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	±20	V
Continuous Drain Current	$I_D$ ①	-100	A
Pulsed Drain Current	$I_{DM}$ ②	-400	A
Single Pulsed Avalanche Energy	$E_{AS}$ ③	100	mJ
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	62.5	°C/W
Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.92	°C/W
Junction Temperature	$T_J$	150	°C
Storage Temperature Range	$T_{stg}$	-55 ~+150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10s)	$T_L$	260	°C

# MOSFET ELECTRICAL CHARACTERISTICS

$T_a=25^\circ\text{C}$  unless otherwise specified

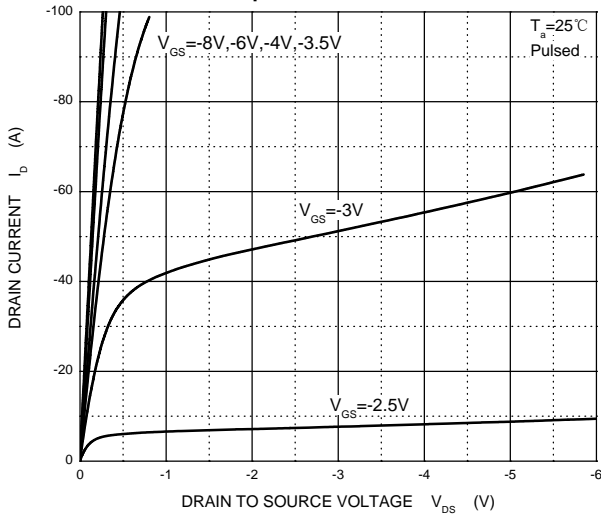
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Off characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-30			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=-24V, V_{GS}=0V$			-1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 100$	nA
<b>On characteristics</b> <sup>④</sup>						
Gate-threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.2	-1.6	-2.2	V
Static drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-30A$		2.3	3.3	$m\Omega$
		$V_{GS}=-4.5V, I_D=-20A$		3.4	5.0	$m\Omega$
Forward transconductance	$g_{FS}$	$V_{DS}=-10V, I_D=-3A$		20		S
<b>Dynamic characteristics</b> <sup>④ ⑤</sup>						
Input capacitance	$C_{iss}$	$V_{DS}=-25V, V_{GS}=0V,$ $f=1MHz$		7930	12000	pF
Output capacitance	$C_{oss}$			985	1300	
Reverse transfer capacitance	$C_{rss}$			505	750	
Gate resistance	$R_g$	$f=1MHz$		3.2		$\Omega$
<b>Switching characteristics</b> <sup>④ ⑤</sup>						
Total gate charge	$Q_g$	$V_{GS}=-10V, V_{DS}=-24V,$ $I_D=-10A$		146	210	nC
Gate-source charge	$Q_{gs}$			22	44	
Gate-drain charge	$Q_{gd}$			32	64	
Turn-on delay time	$t_{d(on)}$	$V_{DS}=-15V, R_L=5\Omega,$ $V_{GS}=-10V, R_G=5\Omega$		17	34	ns
Turn-on rise time	$t_r$			61	120	
Turn-off delay time	$t_{d(off)}$			200	400	
Turn-off fall time	$t_f$			113	220	
<b>Drain-Source Diode Characteristics</b>						
Drain-source diode forward voltage	$V_{SD}$ <sup>④</sup>	$V_{GS}=0V, I_S=-10A$			-1.0	V
Continuous drain-source diode forward current	$I_S$ <sup>①</sup>				-100	A
Pulsed drain-source diode forward current	$I_{SM}$ <sup>②</sup>				-400	A

Notes:

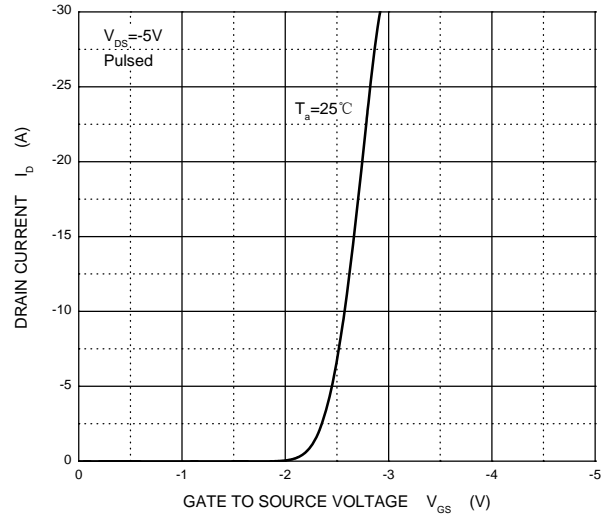
- $T_C=25^\circ\text{C}$  Limited only by maximum temperature allowed.
- $P_W \leq 10\mu s$ , Duty cycle  $\leq 1\%$ .
- EAS condition:  $V_{DD}=-20V, V_{GS}=-10V, L=0.1mH, R_g=25\Omega$  Starting  $T_J=25^\circ\text{C}$ .
- Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- Guaranteed by design, not subject to production.

# Typical Characteristics

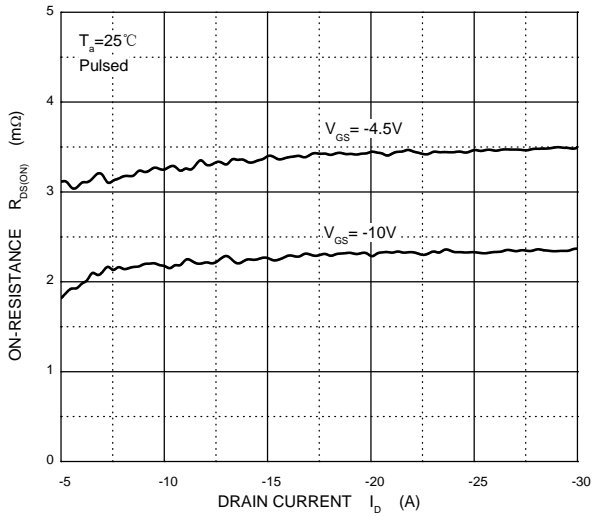
**Output Characteristics**



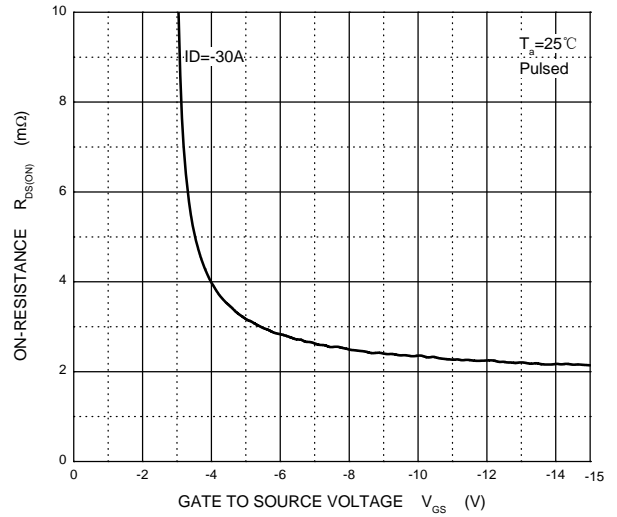
**Transfer Characteristics**



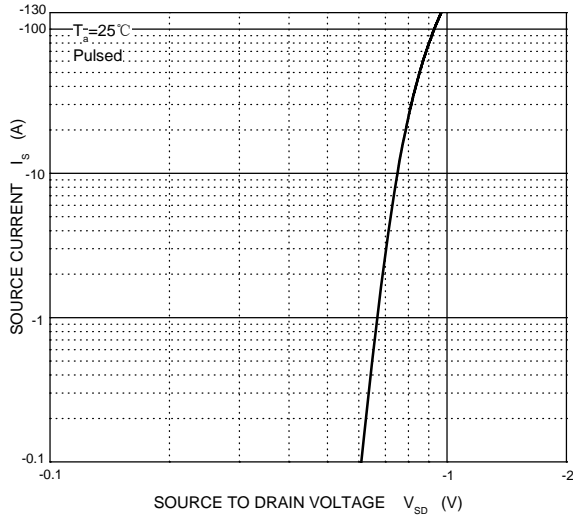
**$R_{DS(ON)}$  —  $I_D$**



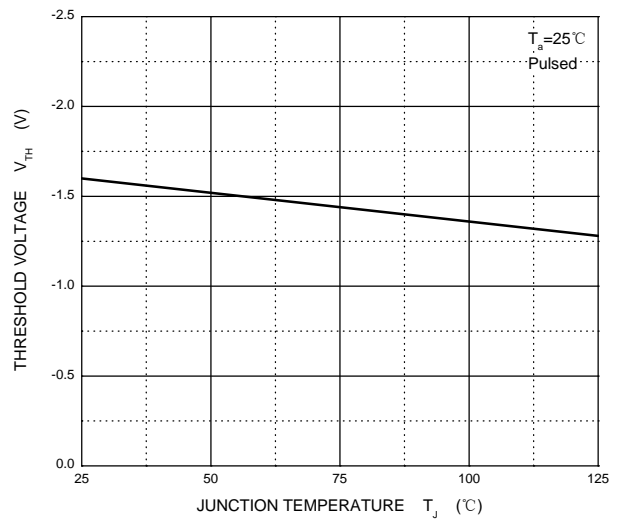
**$R_{DS(ON)}$  —  $V_{GS}$**



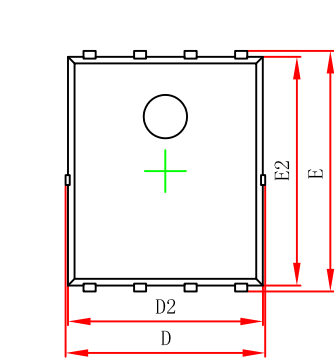
**$I_S$  —  $V_{SD}$**



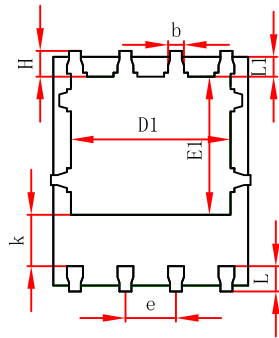
**Threshold Voltage**



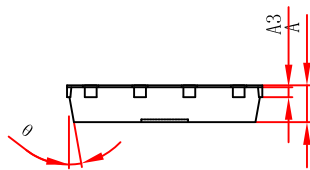
## PDFNWB5x6-8L Package Outline Dimensions



Top View  
[顶视图]



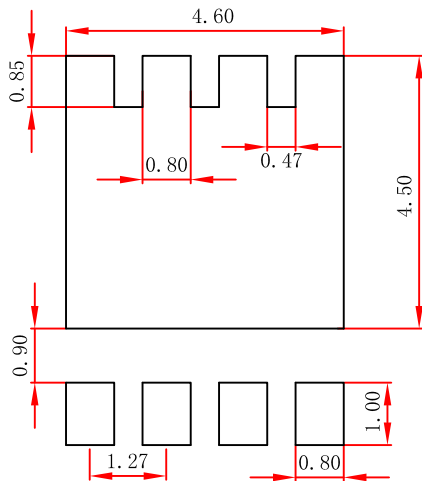
Bottom View  
[背视图]



Side View  
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°

## PDFNWB5x6-8L Suggested Pad Layout



**Note:**

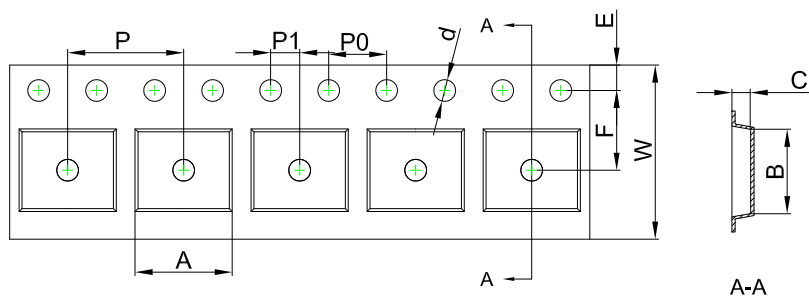
1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05\text{mm}$ .
3. The pad layout is for reference purposes only.

### NOTICE

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# PDFNWB5×6 Tape and Reel

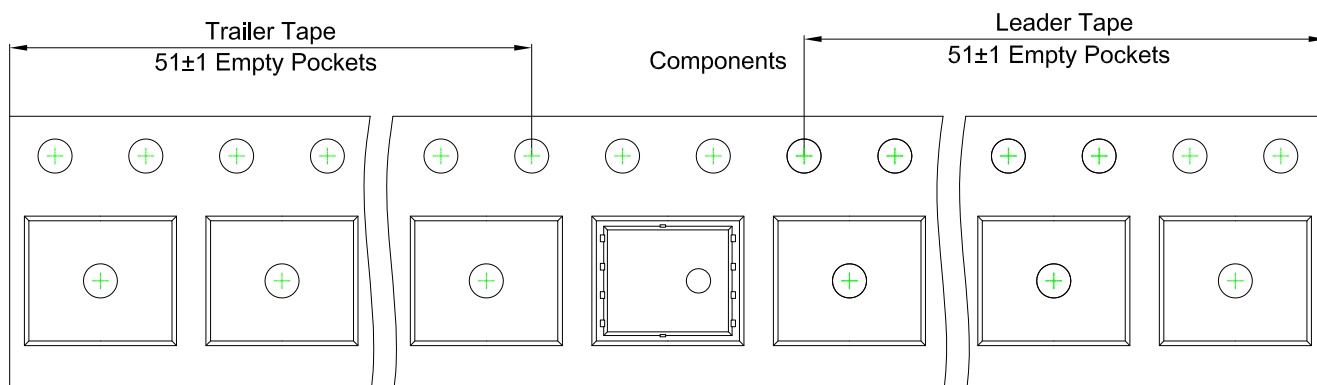
## PDFNWB5×6-8L Embossed Carrier Tape



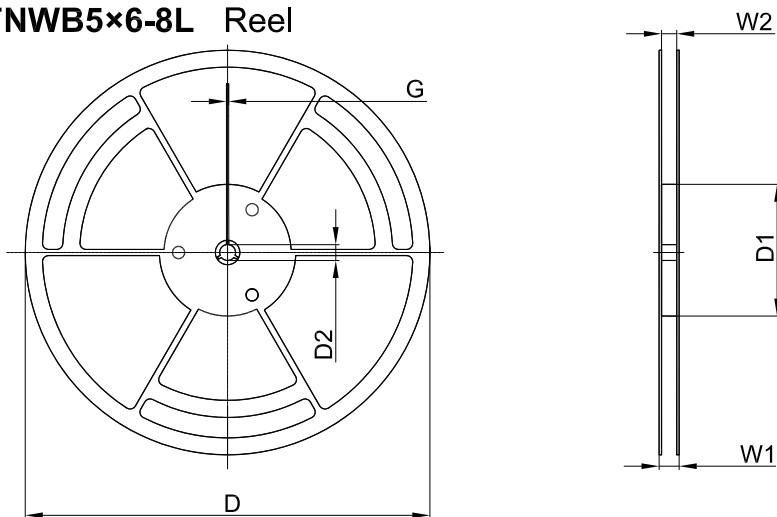
**Packaging Description:**  
**PDFNWB5×6-8L** parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
PDFNWB5×6-8L	6.30	5.30	1.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

## PDFNWB5×6-8L Tape Leader and Trailer



## PDFNWB5×6-8L Reel



Dimensions are in millimeter						
Reel Option	D	D1	D2	G	W1	W2
13"Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365